U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office U.S. Patent and Trademark Office U.S. Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies)
2. Name and address of receiving party(ies)
2. Name and address of receiving party(ies)
Name: MICRON TECHNOLOGY, INC. WILLIAM Internal Address: Legal Department
Mail Stop 525
Street Address: 8000 South Federal Way
City: Boise State: ID Zip: 83706 Additional name(s) & address(es) attached? Yes No
uttached? ☐ Yes ☒ No
6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41)\$ 40.00
Enclosed
Authorized to be charged to deposit account
8. Deposit account number:
07-1857 (Attach duplicate copy of this page if paying by deposit account)
E THIS SPACE

otal number of pages including cover sneet, attachments, and document
Mail documents to be recorded with required cover sheet information to:

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

AARON M. SCHOENFELD DAVID J. CORISIS TYLER J. GOMM

Serial No.:

Filing Date: Concurrently Herewith

Title:

SEMICONDUCTOR COMPONENT WITH ADJUSTMENT

CIRCUITRY AND METHOD OF FABRICATION

Docket No. 01-1187

ASSIGNMENT:

<u> X</u>	Enclosed for recording
	Previously recorded
Date:	
Reel:	

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency, and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN, AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which will be executed by the undersigned and is entitled: SEMICONDUCTOR COMPONENT WITH ADJUSTMENT CIRCUITRY AND METHOD OF FABRICATION; such application and all divisional, continuing, substitute, renewal, reissue, and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

> PATENT REEL: 012888 FRAME: 0024

AUTHORIZE AND REQUEST, the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned:

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney, and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining, and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives, and successors of the undersigned and extend to the successors, assigns, and nominees of the Assignee.

STATE OF IDAHO

}ss.

COUNTY OF ADA

BEFORE ME, this 12 day of 1 2002, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

> Notar√ or donsular Officer of the United States of America

My Commission Expires: 8/12/07

MICRON TECHNOLOGY, INC.

Docket No. 01-1187

STATE OF IDAHO

COUNTY OF ADA

}ss.

BEFORE ME, this 16th day of 2002, personally appeared the #bove named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

Notary or Consular Officer of the United States of America

My Commission Expires: 05-24-07

(Signature)

Date April 12, 200 Z

STATE OF IDAHO

}ss.

COUNTY OF ADA

BEFORE ME, this 12 day of 2002, personally appeared the above individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

SEAL

Notary or Consular Officer of the United States of America

My Commission Expires: _\X\lo\Z

MICRON TECHNOLOGY, INC.

Docket No. 01-1187

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

AARON M. SCHOENFELD DAVID J. CORISIS TYLER J. GOMM

Serial No.:

Filing Date: Concurrently Herewith

Title: SEMICONDUCTOR COMPONENT WITH ADJUSTMENT

CIRCUITRY AND METHOD OF FABRICATION

Docket No. 01-1187

ASSIGNMENT:

X	Enclosed for recording
····	Previously recorded
Date:	
Reel:	

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency, and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN, AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which will be executed by the undersigned and is entitled: SEMICONDUCTOR COMPONENT WITH ADJUSTMENT CIRCUITRY AND METHOD OF FABRICATION; such application and all divisional, continuing, substitute, renewal, reissue, and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

> PATENT REEL: 012888 FRAME: 0027

AUTHORIZE AND REQUEST, the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned:

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney, and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining, and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives, and successors of the undersigned and extend to the successors, assigns, and nominees of the Assignee.

STATE OF IDAHO

lss.

COUNTY OF ADA

BEFORE ME, this 12 day of A2 2002, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

United States of America

My Commission Expires: 8/12/07

MICRON TECHNOLOGY, INC.

Docket No. 01-1187

Date 4/16/02

STATE OF IDAHO

COUNTY OF ADA

}ss.

BEFORE ME, this 6 day of 2002, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein

expressed.



Notary or Consular Officer of the United States of America

My Commission Expires: 05-24-07

(Signature)

TYLER J. GOMM

Date April 12, 200 Z

STATE OF IDAHO

}ss.

COUNTY OF ADA

BEFORE ME, this 12 day of 4,2002, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.

SEAL

Notary or Consular Officer of the United States of America

My Commission Expires: 8/12/02

MICRON TECHNOLOGY, INC.

Docket No. 01-1187

PATENT REEL: 012888 FRAME: 0029

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